CLAIMS

Accordingly, what is claimed is:

- 1. An electronic device comprising:
 - a first volume bounded by a first face;
 - a second volume bounded by a second face;

the second face indented from the first face;

a plurality of electronic components housed in the first volume;

one or more power supplies housed in the second volume; and

the electronic components operable to be powered by a cord to the one or more of the plurality of power supplies, the cord running from the indented second face to the first face.

- 2. The device of claim 1 wherein the second face is higher than the first face.
- 3. The device of claim 1 wherein the second face is lower than the first face.
- 4. The device of claim 1 the one or more power supplies is a plurality of power supplies.
- 5. The device of claim 4 wherein at least two of power supplies are disposed in separate sub-volumes of the second volume, separated by a structure disposed within the second volume.
- 6. The device of claim 5 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
- 7. The device of claim 6 wherein the cover comprises structures that approximate the structures disposed within the second volume.

- 8. The device of claim 1 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
- 9. The device of claim 1 wherein the second volume is operable to be coupled to the first volume.
- 10. The device of claim 1 wherein the first face is approximately parallel to the second face.
- 11. The device of claim 1 wherein the first face is not approximately parallel to the second face.
- 12. An enclosure for an electronic system comprising:
 - a first chassis, operable to enclose a plurality of electronic components, comprising:
 - a first face;
 - a second face opposite the first face;
- electrical connections, for transferring electrical energy to any enclosed electronic components, disposed through the first face;
- a second chassis, operable to enclose one or more power supplies, having a third face; and

wherein a portion of the third face is disposed in a plane that intersects the volume disposed between the first face and the second face.

- 13. The enclosure of claim 12 wherein the second chassis is higher than the first chassis.
- 14. The enclosure of claim 12 wherein the second chassis is lower than the first chassis.

- 15. The enclosure of claim 12 the second chassis is operable to enclose a plurality of power supplies.
- 16. The enclosure of claim 15 wherein at least two of power supplies are operable to be disposed in separate sub-volumes of the second chassis, separated by a structure disposed within the second chassis.
- 17. The enclosure of claim 16 further comprising a cover, the cover operable to project an outline upon the second chassis that approximates the dimension of the first face.
- 18. The enclosure of claim 17 wherein the cover comprises structures that approximate the structures disposed within the second chassis.
- 19. The enclosure of claim 12 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
- 20. The enclosure of claim 12 wherein the second chassis is operable to be selectively coupled to and uncoupled from the first chassis.
- 21. The enclosure of claim 12 wherein the first face is approximately parallel to the second face.
- 22. The enclosure of claim 12 wherein the first face is not approximately parallel to the second face.
- 23. The enclosure of claim 12 further comprising a plurality of first chasses.

- 24. The enclosure of claim 12 further comprising a plurality of second chasses.
- 25. An enclosure for an electronic system comprising:
 - a first chassis comprising:

a first volume operable to enclose a plurality of electronic components, the first volume defined by a first face and a second face opposite the first face;

electrical connections, for transferring electrical energy to any enclosed electronic components, disposed through the first face;

a second chassis comprising:

a second volume, operable to enclose one or more power supplies, defined at least in part by a third face; and

wherein the third face and the first face define an indentation, and the second volume is indented from the first volume.

- 26. The enclosure of claim 25 wherein the second chassis is higher than the first chassis.
- 27. The enclosure of claim 25 wherein the second chassis is lower than the first chassis.
- 28. The enclosure of claim 25 the second chassis is operable to enclose a plurality of power supplies.
- 29. The enclosure of claim 28 wherein at least two of power supplies are operable to be disposed in separate sub-volumes of the second chassis, separated by a structure disposed within the second chassis.

- 30. The enclosure of claim 29 further comprising a cover, the cover operable to project an outline upon the second chassis that approximates the dimension of the first face.
- 31. The enclosure of claim 30 wherein the cover comprises structures that approximate the structures disposed within the second chassis.
- 32. The enclosure of claim 25 further comprising a cover, the cover operable to project an outline upon the indentation that approximates the dimension of the first face.
- 33. The enclosure of claim 25 wherein the second chassis is operable to be selectively coupled to and uncoupled from the first chassis.
- 34. The enclosure of claim 25 wherein the first face is approximately parallel to the third face.
- 35. The enclosure of claim 25 wherein the first face is not approximately parallel to the third face.
- 36. The enclosure of claim 25 further comprising a plurality of first chasses.
- 37. The enclosure of claim 25 further comprising a plurality of second chasses.
- 38. An enclosure for an electronic system comprising:

means for enclosing a plurality of electronic components, defined by a first face and a second face opposite the first face;

means for making electrical connections disposed through the first face;

means for enclosing one or more power supplies, defined at least in part by a third face; and

wherein the third face and the first face define an indentation.